BR460-1 Pro

LED Display Control Board

Specifications

Change History

Document Version	Release Date	Description
V1.0.1	2026-04-17	Updated the maximum load capacity.
V1.0.0	2025-07-14	First release.

Introduction

The BR460-1 Pro is an LED display control board developed by NovaStar Tech Co., Ltd. (hereinafter referred to as NovaStar). It is integrated with a power module that can convert 90 VAC to 264 VAC into direct current, which directly powers the screen modules. Furthermore, the product offers functions such as undervoltage, overvoltage, overcurrent, overpower, and short-circuit protections, ensuring safety, high efficiency, and good reliability.

For PWM driver ICs, the maximum load capacity per card is:

- 512×512@60Hz (For 8bit video sources)
- 512×256@60Hz (For 10bit and 12bit video sources)

Note

For PWM driver ICs, when working with COEX controllers and 10bit video sources, the maximum load capacity per card is 512×512@60Hz.

Features

- Power Module and Receiving Card in One Package

  The product supports input voltage of 90 VAC to 264 VAC and converts it to direct current to directly power the modules. Furthermore, the product offers functions such as undervoltage, overvoltage, overcurrent, overpower, and short-circuit protections.

- Image Booster (Effects depend on driver IC)
  - Color Management: Support standard (Rec.709 / DCI-P3 / Rec.2020) and custom color gamuts, enabling more precise colors on the screen.
  - Precise Grayscale: Individually correct the 65,536 levels of grayscale (16bit) of the driver IC to fix the display problems at low grayscale conditions, such as brightness spikes,

brightness dips, color cast and mottling. This function can also better assist other display technologies, such as 22bit+ and individual gamma adjustment for RGB, allowing for a smoother and uniform image.

  - 22bit+: Improve the LED screen grayscale by 64 times to avoid grayscale loss due to low brightness and allow for a smoother image with more details in dark areas.

- Thermal Compensation 2.0

  Work with NovaStar's high-precision calibration system to precisely collect the thermal distribution data of LED cabinets and generate unique thermal compensation data for each pixel of the cabinets, effectively eliminating the cabinet or module level # shaped bars caused by uneven thermal distribution.

- HDR
  - Support HDR10 and comply with the SMPTE ST 2084 and SMPTE ST 2086 standards.
  - Support HLG.
- Pixel Level Brightness and Chroma Calibration

  Work with NovaStar's calibration system to calibrate the brightness and chroma of each pixel, effectively eliminating differences and enabling high consistency for both brightness and chroma.

- Quick Adjustment of Dark or Bright Lines

  The different brightness of seams caused by splicing of modules or cabinets can be corrected to improve the visual experience. The correction is easy and takes effect immediately.

- Multi-batch Adjustment

  Adjust the brightness of cabinets or modules to minimize display discrepancies caused by variations in production batches.

- Low Latency

  The latency of video source on the receiving card end can be reduced to 1 frame (only when using modules with driver IC with built-in RAM).

- 3D

  Work with the controller that supports 3D function to enable 3D output.

- Individual Gamma Adjustment for RGB

  Working with NovaLCT and the controller that supports this function, the receiving card supports individual adjustment to red gamma, green gamma and blue gamma, which can effectively control image non-uniformity at low grayscale conditions and white balance offset, allowing for a more realistic image.

- 90° Image Rotation

  The display image can be rotated in multiples of 90° (0°/90°/180°/270°).

- Free Image Rotation

  Support image rotation at any angle when using the dedicated MCTRL R5 controller and SmartLCT software.

- One-Click Sleep

  Paired with NovaLCT for power management, enabling energy-saving with one simple click.

- Smart Module (dedicated firmware required)

  Work with the smart module to support module ID management, storage of calibration coefficients and module parameters, monitoring of module temperature, voltage and flat cable communication status, and LED error detection

- Calibration Coefficient Management

  The calibration coefficients can be uploaded, read back, saved to hardware, and erased.

- Automatic Module Calibration

  After a new module with flash memory is installed to replace the old one, the calibration coefficients stored in the flash memory can be automatically uploaded to the receiving card when it is powered on, which ensures unchanged uniform display brightness and chroma.

- Uploading Calibration Coefficients

  Upload calibration coefficients to the receiving card quickly or in a stable manner, with acceleration support if needed.

- Module Flash Management

  For modules with flash memory, the information stored can be managed, allowing for the storage and readback of calibration coefficients and module IDs.

- One-click to Apply Calibration Coefficients in Module Flash

  For modules with flash memory, when the Ethernet cable is disconnected, users can hold down the self-test button on the cabinet to upload the calibration coefficients in the memory of the module to the receiving card.

- Data Group Mapping

  Display the test pattern by data group to clearly show the position of each data group within the cabinet.

- Mapping 1.1

  The cabinet displays the Ethernet port, receiving card, and controller numbers in different colors, clearly showing the physical locations and connection topology of receiving cards.

- Settings of a Stored Image in the Receiving Card

  The image displayed during startup, or displayed when the Ethernet cable is disconnected or there is no video signal can be customized.

- Temperature and Voltage Monitoring

  Real-time monitoring of the temperature and voltage of the receiving card, without the need for other external devices.

- Bit Error Detection

  Real-time monitoring of the communication of the Ethernet port on the receiving card which helps users troubleshoot network communication problems.

- Detection of Ethernet Cable Disconnections

  Monitors the number of times the Ethernet cable to the receiving card is disconnected, assisting in identifying potential communication link issues.

- Firmware Program Readback

  The receiving card firmware program can be read back and saved to the local computer.

- Configuration Parameter Readback

  The receiving card configuration parameters can be read back and saved to the local computer.

- Dual NCP Backup

  The NCP file is stored in the application area and factory area of the receiving card at the same time. Typically, the NCP file in the application area is used. However, during a factory reset, the NCP file can be retrieved from the factory area.

- Loop Backup

  The receiving card and controller form a loop via the primary and backup line connections. When a fault occurs at a location of the lines, the screen can still display the image normally.

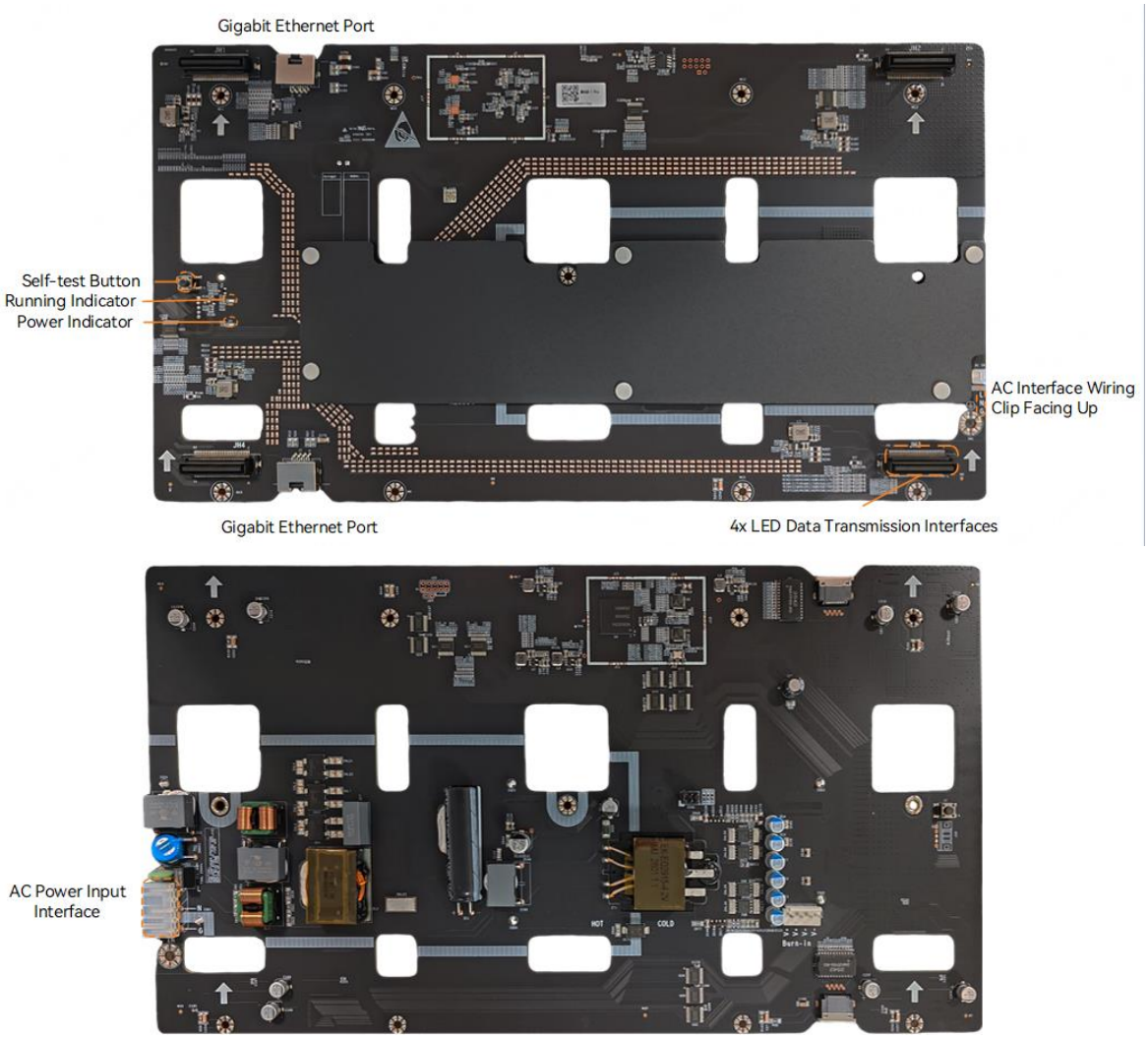
- Dual Backup of Configuration Parameters

  The receiving card configuration parameters are stored in the application area and factory area of the receiving card at the same time. Users usually use the configuration parameters in the application area. If necessary, users can restore the configuration parameters in the factory area to the application area.

- Dual Program Backup

  Two copies of firmware program are stored in the receiving card at the factory to avoid the problem that the receiving card may get stuck abnormally during program update.

Appearance



All product pictures shown in this document are for illustration purpose only. Actual product may vary.

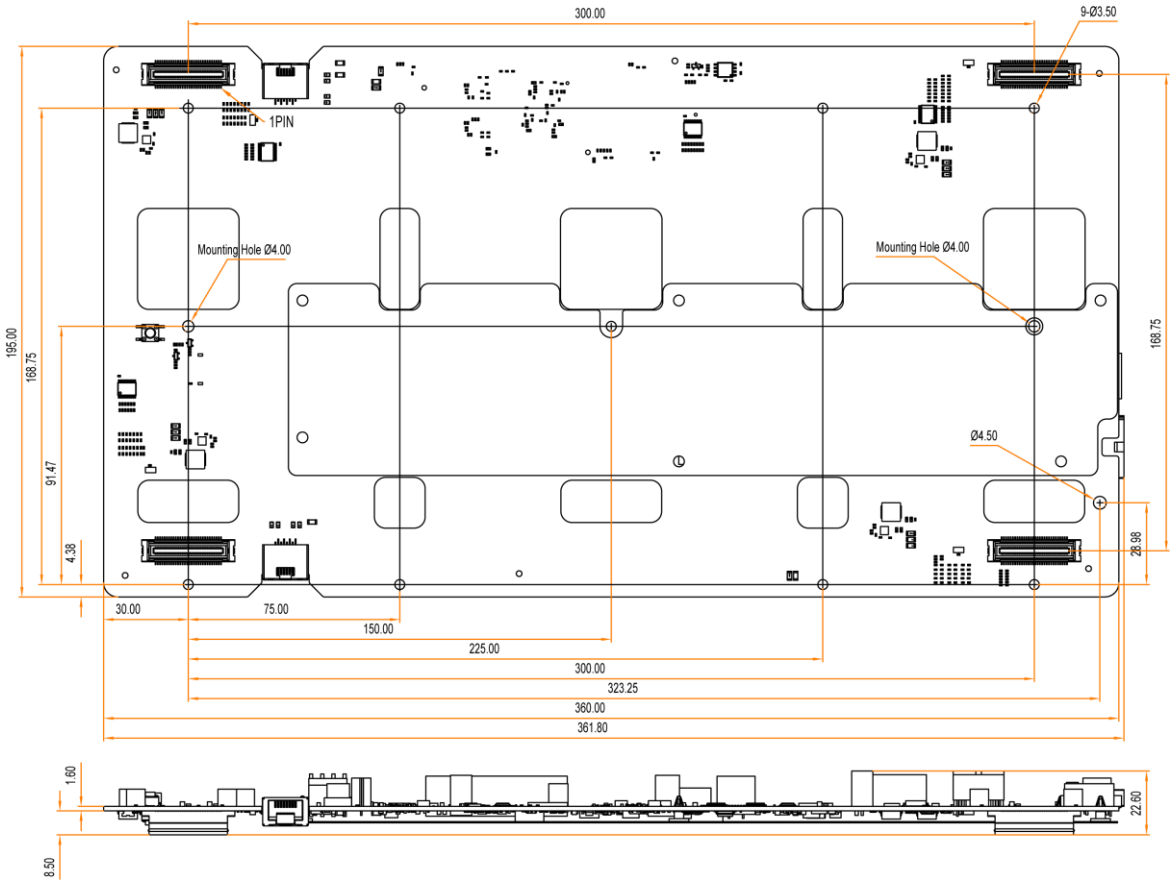
Indicator

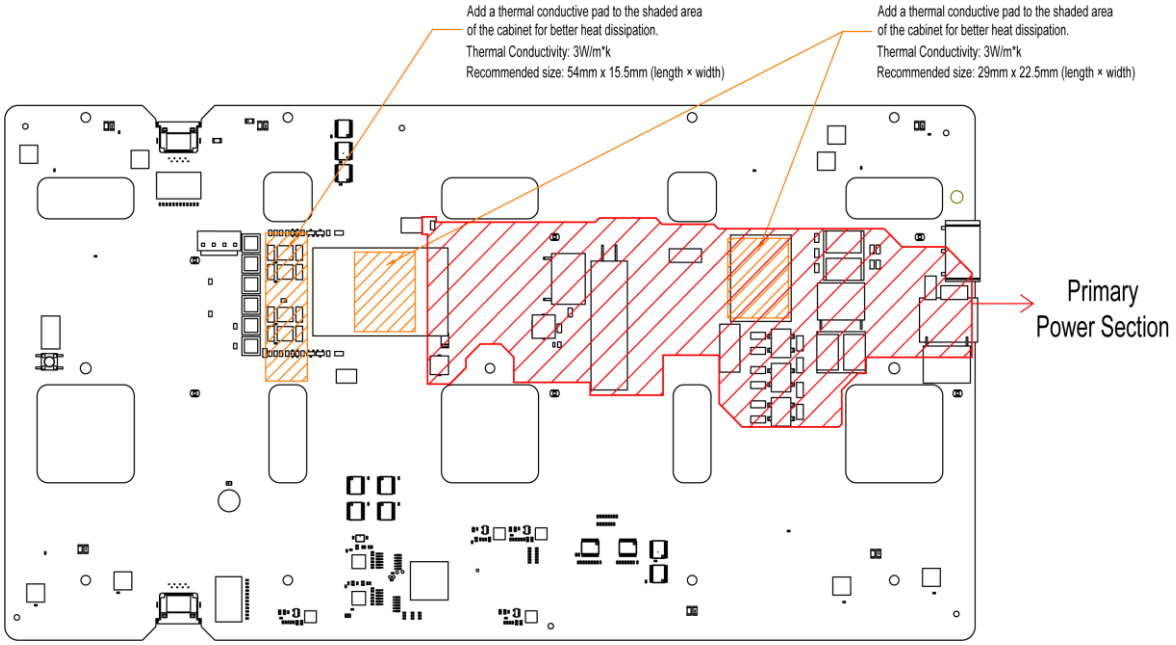
Indicators	Color	Status	Description
Running indicator	Green	Flashing once every 1s	The receiving card is functioning normally. Ethernet cable connection is normal, and video source input is available.
		Flashing once every 3s	Ethernet cable connection is abnormal.
		Flashing 3 times	Ethernet cable connection is normal, but video source

Indicators	Color	Status	Description
		every 0.5s	input is unavailable.
		Flashing once every 0.2s	The receiving card failed to load the program in the application area and is now using the backup program.
		Flashing 8 times every 0.5s	A redundancy switchover occurred on the Ethernet port and the loop backup has taken effect.
Power indicator	Red	Always on	The power input is normal.

Dimensions

The board thickness is not greater than 2.0 mm, and the total thickness (board thickness + thickness of components on the top and bottom sides) is not greater than 23.0 mm.



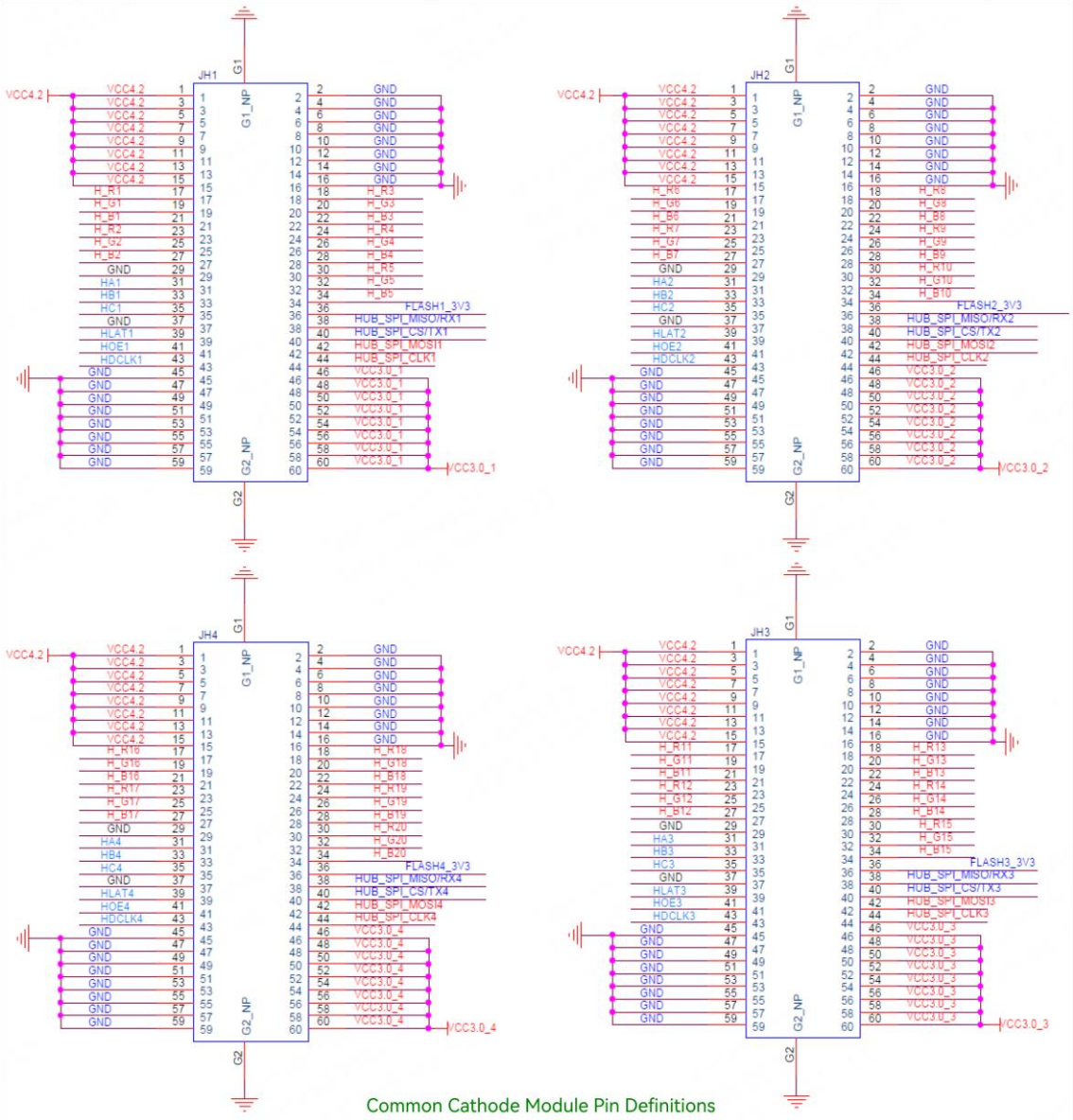


Tolerance: ±0.3 Unit: mm

Note

- To make molds or trepan mounting holes, please contact NovaStar for a higher-precision structural drawing.
- The thermal conductive pad and silicone insulation pad are not included with the product. You will need to adhere them yourself according to the specified positions and sizes in the diagram. Attach the thermal conductive pad to the card, ensuring the thickness is appropriate for the available space in the cabinet and that it is compressed when in place. The silicone insulation pad should be adhered to the cabinet.
- The red shaded area in the diagram is the primary power section. Ensure a safety distance of at least 5 mm between this area and the metal conductor of the cabinet. If this distance is not met, add a silicone insulation pad for additional insulation. Design the silicone pad to extend more than 5 mm beyond the primary power section.
- For other areas, maintain a safety distance of at least 2 mm from the cabinet.
- The silicone pad should be 0.23 mm thick, with a voltage resistance of ≥ AC/4KV and a thermal conductivity of ≥ 1.6 W/m.k.

Pins



Common Cathode Module Pin Definitions

Pin Definitions (JH1 as an example)					
/	VCC4.2	1	2	GND	/
/	VCC4.2	3	4	GND	/
/	VCC4.2	5	6	GND	/
/	VCC4.2	7	8	GND	/
/	VCC4.2	9	10	GND	/
/	VCC4.2	11	12	GND	/
/	VCC4.2	13	14	GND	/

Pin Definitions (JH1 as an example)					
/	VCC4.2	15	16	GND	/
/	H_R1	17	18	H_R3	/
/	H_G1	19	20	H_G3	/
/	H_B1	21	22	H_B3	/
/	H_R2	23	24	H_R4	/
/	H_G2	25	26	H_G4	/
/	H_B2	27	28	H_B4	/
/	GND	29	30	H_R5	/
Line decoding signal	HA1	31	32	H_G5	/
Line decoding signal	HB1	33	34	H_B5	/
Line decoding signal	HC1	35	36	FLASH1_3V3	3.3V module flash power supply
/	GND	37	38	HUB_SPI_MISO/RX1	Module flash data storage output / Smart module RX signal (optional)
Latch signal	HLAT1	39	40	HUB_SPI_CS/TX1	CS signal of serial pin / Smart module TX signal (optional)
Display enable signal	HOE1	41	42	HUB_SPI_MOSI1	Module flash data storage input
Shift clock	HDCLK1	43	44	HUB_SPI_CLK1	Clock signal of serial pin
/	GND	45	46	VCC3.0_1	/
/	GND	47	48	VCC3.0_1	/
/	GND	49	50	VCC3.0_1	/
/	GND	51	52	VCC3.0_1	/
/	GND	53	54	VCC3.0_1	/
/	GND	55	56	VCC3.0_1	/
/	GND	57	58	VCC3.0_1	/

Pin Definitions (JH1 as an example)					
/	GND	59	60	VCC3.0_1	/

Electrical Specifications

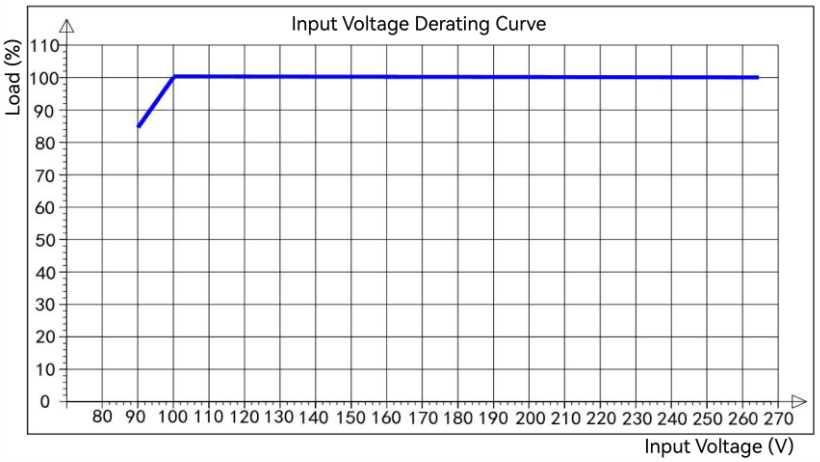
Input Specifications

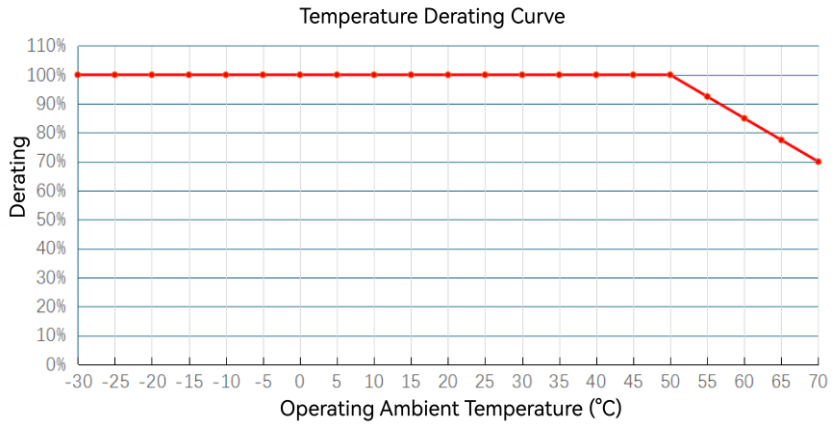
Input Voltage	90 VAC to 264 VAC
Nominal Input	100 VAC to 240 VAC
Frequency Range	47 Hz to 63 Hz
Starting Voltage	> 70 VAC
Maximum Input Current	1.8 A
Inrush Current	Cold start: 100 A at 240 VAC, 50 A at 100 VAC
Power Factor	@240 VAC, ≥ 0.90; @100 VAC, ≥ 0.97 (tested at 32 A)
Current Harmonics	GB17625.1; EN61000-3-2,-3
Standby Power Consumption	≤ 4 W
Input Fuse	T5AL/250 VAC

Output Specifications

Output Current	32 A (Rated) Note: The peak current is tested with a pulse width of less than 100ms and at an ambient temperature of 30°C.
Output Voltage	Adjustable: 3.8 V/4.0 V/4.2 V Low voltage: 3.0 V Offers three adjustable settings, which can be changed by simply connecting a jumper cap.
Output Voltage Accuracy	±2.0%
Line Regulation	±2.0%
Load Regulation	±2.0%
Output Ripple Noise	≤ 200 mV

	Note: In an environment of 25°C, the bandwidth is set to 20 MHz. A 0.1 μF ceramic capacitor and a 10 μF electrolytic capacitor are connected in parallel at the output for testing.
Temperature Coefficient	Pending
Dynamic Load Performance	0% to 50% load and 50% to 100% load, < 10%
Efficiency	@ 240 Vac, 88%, CH1 32A @ 100 Vac, 84%, CH1 32A
Output Rise Time	30.0 ms max Note: Rise time is defined as the time it takes for the output voltage to increase from 10% to 90%. This is tested with a 0.1 μF ceramic capacitor and a 10 μF electrolytic capacitor connected in parallel at the output.
Start-up Delay Time	Max 1s at 220 VAC
Output Hold Time	@ 240 VAC, 15 ms @ 100 VAC, 10 ms
Output Voltage Overshoot	10% max Note: All DC output currents should range from minimum to maximum values.
Capacitive Load	32,000 μF
Ratio Radiation Emission	Pending
Switching Frequency	Pending
Power Temperature Derating	-20°C to +70°C (Above 50°C, load capacity is reduced by 1.5% for every additional 1°C.)
Power Input Voltage Derating	Between 90 VAC and 100 VAC (For every 1 V decrease, load capacity is reduced by 1.5%.)
MTBF	≥ 150,000 hours at 25°C ambient temperature, with full load and normal input





Protection

Input Undervoltage Protection	Engages above 70 VAC, disengages below 65 VAC
Output Overvoltage Protection	< 6.5 V, self-recovery
Output Overcurrent Protection	Triggered at 1.3 to 1.6 times of rated current
Output Overpower Protection	Triggered at 1.3 to 1.6 times of rated current
Output Short-circuit Protection	Self-recovery

Safety

Insulation Resistance	Input to output 500 VDC, 100 MΩ min (at room temperature)
Insulation Withstand Voltage	Input to output (I/P-O/P): 3.0 kVAC / 10 mA Input to case (I/P-CASE): 1.8 kVAC / 10 mA Note: This refers to AC withstand voltage. The DC withstand voltage is 1.414 times the AC withstand voltage,

	while the leakage current remains the same.
Ground Resistance	< 0.1 Ω

Note

If there are lightning protection components in the circuit, the following steps should be taken during the voltage withstand test after disconnecting the air gap tube:

- The input lines (L&N) need to be short-circuited together, and all the output lines need to be short-circuited together.
- Input to output: Input short-circuit line to output short-circuit line test.
- Input to FG: Input short-circuit line to FG.

EMC

Conducted Emission	GB/T9254.1-2021/EN55032/FCC, Class A
Radiated Emission	GB/T9254.1-2021/EN55032/FCC, Class A
Power Fluctuation and Flicker	Pending
Radiated Susceptibility	EN55024; EN61000-4-2, 3, 4, 5, 6, 8, 11
Conducted Susceptibility	EN55024; EN61000-4-2, 3, 4, 5, 6, 8, 11
Surge Susceptibility	GB17626.5/IEC61000-4-5 Performance Criteria: B DM: ±2 kV, CM: ±4 kV
EFT Immunity	GB17626.4/IEC61000-4-4 Performance Criteria: B ±3 kV
ESD Immunity	GB17626.2/IEC61000-4-2 Performance Criteria: B Contact ±4 kV, Air ±8 kV
Voltage Fluctuation and Flicker	Pending
Voltage Drop	GB17626.11/IEC61000-4-11 Performance Criteria: B/C

Voltage Drop Requirements:

Voltage Drop	Duration	Performance Criteria
0% Ut	10ms	B

Voltage Drop	Duration	Performance Criteria
70% Ut	500ms	C
40% Ut	200ms	C
0% Ut	5000ms	C

Caution

It is required to comply with the above-mentioned standards as a whole system.
If the product does not have the relevant certifications required by the countries or regions where it is to be sold, please contact NovaStar to confirm or address the problem. Otherwise, the customer shall be responsible for the legal risks caused or NovaStar has the right to claim compensation.

Specifications

Maximum Resolution	For PWM driver ICs, the maximum load capacity per card is: • 512×512@60Hz (For 8bit video sources) • 512×256@60Hz (For 10bit and 12bit video sources)	
Operating Environment	Temperature	–20°C to +70°C (Above 50°C, load capacity is reduced by 1.5% for every additional 1°C.)
	Humidity	10% RH to 90% RH, non-condensing
	Altitude	-60 m to +5000 m Note: For every 100 meters above 2000 meters in altitude, the maximum operating temperature decreases by 0.5°C.
Storage Environment	Temperature	–40°C to +85°C
	Humidity	5% RH to 95% RH, non-condensing
	Altitude	< 5000 m
Physical Specifications	Dimensions	361.8 mm × 195.0 mm × 22.6 mm
	Net weight	365.0 g Note: It is the weight of a single receiving card only.
Packing Information	Packaging	An antistatic bag is provided for each board. Each packing box contains 14 boards.
	Packing box	635.0 mm × 595.0 mm × 283.0 mm

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Statement

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